

HD74AC245/HD74ACT245

Octal Bi-directional Transceiver with 3-State Input/Output

REJ03D0263-0200Z
(Previous ADE-205-384 (Z))
Rev.2.00
Jul.16.2004

Description

The HD74AC245/HD74ACT245 contains eight non-inverting bidirectional buffers with 3-state outputs and is intended for bus-oriented applications. Current sinking capability is 24 mA at both the A and B ports. The Transmit/Receive ($T/\bar{R}$) input determines the direction of data flow through the bidirectional transceiver. Transmit (active-High) enables data from A ports to B ports; Receive (active-Low) enables data from B ports to A ports. The Output Enable input, when High, disables, both A and B ports by placing them in a High Z condition.

Features

- Noninverting Buffers
- Bi-directional Data Path
- A and B Outputs Source/Sink 24 mA
- HD74ACT245 has TTL-Compatible Inputs
- Ordering Information: Ex. HD74AC245

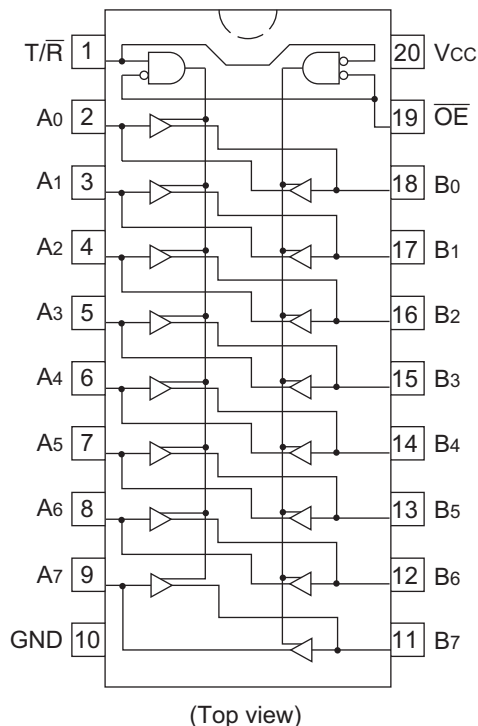
Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74AC245P	DIP-20 pin	DP-20N, -20NEV	P	—
HD74AC245FPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74AC245RPEL	SOP-20 pin (JEDEC)	FP-20DBV	RP	EL (1,000 pcs/reel)
HD74AC245TELL	TSSOP-20 pin	TTP-20DAV	T	ELL (2,000 pcs/reel)

Notes: 1. Please consult the sales office for the above package availability.
2. The packages with lead-free pins are distinguished from the conventional products by adding V at the end of the package code.

Pin Names

$\overline{OE}$	Output Enable Input
$T/\overline{R}$	Transmit/Receive Input
A_0 to A_7	Side A 3-State Inputs or 3-State Outputs
B_0 to B_7	Side B 3-State Inputs or 3-State Outputs

Pin Arrangement



Truth Tables

Inputs		Outputs
$\overline{OE}$	$T/\overline{R}$	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	High Z State

H : High Voltage Level

L : Low Voltage Level

X : Immaterial

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V_{CC}	-0.5 to 7	V	
DC input diode current	I_{IK}	-20	mA	$V_I = -0.5V$
		20	mA	$V_I = V_{CC}+0.5V$
DC input voltage	V_I	-0.5 to $V_{CC}+0.5$	V	
DC output diode current	I_{OK}	-50	mA	$V_O = -0.5V$
		50	mA	$V_O = V_{CC}+0.5V$
DC output voltage	V_O	-0.5 to $V_{CC}+0.5$	V	
DC output source or sink current	I_O	± 50	mA	
DC V_{CC} or ground current per output pin	I_{CC}, I_{GND}	± 50	mA	
Storage temperature	T_{stg}	-65 to +150	$^{\circ}C$	

Recommended Operating Conditions: HD74AC245

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V_{CC}	2 to 6	V	
Input and Output voltage	V_I, V_O	0 to V_{CC}	V	
Operating temperature	T_a	-40 to +85	°C	
Input rise and fall time (except Schmitt inputs) V_{IN} 30% to 70% V_{CC}	t_r, t_f	8	ns/V	$V_{CC} = 3.0V$ $V_{CC} = 4.5V$ $V_{CC} = 5.5V$

DC Characteristics: HD74AC245

Item	Sym- bol	V_{CC} (V)	$T_a = 25^\circ C$			$T_a = -40 \text{ to } +85^\circ C$		Unit	Condition
			min.	typ.	max.	min.	max.		
Input Voltage	V_{IH}	3.0	2.1	1.5	—	2.1	—	V	$V_{OUT} = 0.1V \text{ or } V_{CC} - 0.1V$
		4.5	3.15	2.25	—	3.15	—		
		5.5	3.85	2.75	—	3.85	—		
	V_{IL}	3.0	—	1.50	0.9	—	0.9		$V_{OUT} = 0.1V \text{ or } V_{CC} - 0.1V$
		4.5	—	2.25	1.35	—	1.35		
		5.5	—	2.75	1.65	—	1.65		
Output voltage	V_{OH}	3.0	2.9	2.99	—	2.9	—	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OUT} = -50 \mu A$
		4.5	4.4	4.49	—	4.4	—		
		5.5	5.4	5.49	—	5.4	—		
		3.0	2.58	—	—	2.48	—		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -24 \text{ mA}$
		4.5	3.94	—	—	3.80	—		
		5.5	4.94	—	—	4.80	—		
	V_{OL}	3.0	—	0.002	0.1	—	0.1		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OUT} = 50 \mu A$
		4.5	—	0.001	0.1	—	0.1		
		5.5	—	0.001	0.1	—	0.1		
		3.0	—	—	0.32	—	0.37		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OL} = 12 \text{ mA}$ $I_{OL} = 24 \text{ mA}$ $I_{OL} = 24 \text{ mA}$
		4.5	—	—	0.32	—	0.37		
		5.5	—	—	0.32	—	0.37		
		3.0	—	—	0.32	—	0.37		
		4.5	—	—	0.32	—	0.37		
		5.5	—	—	0.32	—	0.37		
Input leakage current	I_{IN}	5.5	—	—	± 0.1	—	± 1.0	μA	$V_{IN} = V_{CC} \text{ or GND}$
3 State current	I_{OZ}	5.5	—	—	± 0.5	—	± 5.0	μA	$V_{IN(OE)} = V_{IL}, V_{IH}$ $V_{IN} = V_{CC} \text{ or GND}$ $V_{OUT} = V_{CC} \text{ or GND}$
Dynamic output current*	I_{OLD}	5.5	—	—	—	86	—	mA	$V_{OLD} = 1.1V$
	I_{OHD}	5.5	—	—	—	-75	—	mA	$V_{OHD} = 3.85V$
Quiescent supply current	I_{CC}	5.5	—	—	8.0	—	80	μA	$V_{IN} = V_{CC} \text{ or ground}$

*Maximum test duration 2.0 ms, one output loaded at a time.

Recommended Operating Conditions: HD74ACT245

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V_{CC}	2 to 6	V	
Input and output voltage	V_I, V_O	0 to V_{CC}	V	
Operating temperature	T_a	-40 to +85	°C	
Input rise and fall time (except Schmitt inputs) V_{IN} 0.8 to 2.0 V	t_r, t_f	8	ns/V	$V_{CC} = 4.5V$ $V_{CC} = 5.5V$

DC Characteristics: HD74ACT245

Item	Sym- bol	V _{CC} (V)	Ta = 25°C			Ta = -40 to +85°C		Unit	Condition	
			min.	typ.	max.	min.	max.			
Input voltage	V _{IH}	4.5	2.0	1.5	—	2.0	—	V	V _{OUT} = 0.1 V or V _{CC} -0.1 V	
		5.5	2.0	1.5	—	2.0	—			
	V _{IL}	4.5	—	1.5	0.8	—	0.8		V _{OUT} = 0.1 V or V _{CC} -0.1 V	
		5.5	—	1.5	0.8	—	0.8			
Output voltage	V _{OH}	4.5	4.4	4.49	—	4.4	—	V	V _{IN} = V _{IL} or V _{IH} I _{OUT} = -50 μA	
		5.5	5.4	5.49	—	5.4	—			
		4.5	3.94	—	—	3.80	—		V _{IN} = V _{IL}	I _{OH} = -24 mA
		5.5	4.94	—	—	4.80	—			I _{OH} = -24 mA
	V _{OL}	4.5	—	0.001	0.1	—	0.1		V _{IN} = V _{IL} or V _{IH} I _{OUT} = 50 μA	
		5.5	—	0.001	0.1	—	0.1			
		4.5	—	—	0.32	—	0.37		V _{IN} = V _{IL}	I _{OL} = 24 mA
		5.5	—	—	0.32	—	0.37			I _{OL} = 24 mA
Input current	I _{IN}	5.5	—	—	±0.1	—	±1.0	μA	V _{IN} = V _{CC} or GND	
3 State current	I _{OZ}	5.5	—	—	±0.5	—	±5.0	μA	V _{IN} = V _{IL} , V _{IH} V _{OUT} = V _{CC} or GND	
I _{CC} /input current	I _{CCT}	5.5	—	0.6	—	—	1.5	mA	V _{IN} = V _{CC} -2.1 V	
Dynamic output current*	I _{OLD}	5.5	—	—	—	86	—	mA	V _{OLD} = 1.1 V	
	I _{OHD}	5.5	—	—	—	-75	—	mA	V _{OHD} = 3.85 V	
Quiescent supply current	I _{CC}	5.5	—	—	8.0	—	80	μA	V _{IN} = V _{CC} or ground	

*Maximum test duration 2.0 ms, one output loaded at a time.

AC Characteristics: HD74AC245

Item	Symbol	V _{CC} (V)* ¹	Ta = +25°C C _L = 50 pF			Ta = -40°C to +85°C C _L = 50 pF		Unit
			Min	Typ	Max	Min	Max	
Propagation delay Data to output	t _{PLH}	3.3	1.0	5.0	8.5	1.0	9.0	ns
		5.0	1.0	3.5	6.5	1.0	7.0	
Propagation delay Data to output	t _{PHL}	3.3	1.0	5.0	8.5	1.0	9.0	ns
		5.0	1.0	3.5	6.0	1.0	7.0	
Output enable time	t _{ZH}	3.3	1.0	7.0	11.5	1.0	12.5	ns
		5.0	1.0	5.0	8.5	1.0	9.0	
Output enable time	t _{ZL}	3.3	1.0	7.5	12.0	1.0	13.5	ns
		5.0	1.0	5.5	9.0	1.0	9.5	
Output disable time	t _{HZ}	3.3	1.0	6.5	12.0	1.0	12.5	ns
		5.0	1.0	5.5	9.0	1.0	10.0	
Output disable time	t _{LZ}	3.3	1.0	7.0	11.5	1.0	13.0	ns
		5.0	1.0	5.5	9.0	1.0	10.0	

Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

AC Characteristics: HD74ACT245

Item	Symbol	V_{CC} (V)*1	Ta = +25°C C _L = 50 pF			Ta = -40°C to +85°C C _L = 50 pF		Unit
			Min	Typ	Max	Min	Max	
Propagation delay Data to output	t _{PLH}	5.0	1.0	4.0	7.5	1.0	8.0	ns
Propagation delay Data to output	t _{PHL}	5.0	1.0	4.0	8.0	1.0	9.0	ns
Output enable time	t _{ZH}	5.0	1.0	5.0	10.0	1.0	11.0	ns
Output enable time	t _{ZL}	5.0	1.0	5.5	10.0	1.0	12.0	ns
Output disable time	t _{HZ}	5.0	1.0	5.5	10.0	1.0	11.0	ns
Output disable time	t _{LZ}	5.0	1.0	5.0	10.0	1.0	11.0	ns

Note: 1. Voltage Range 5.0 is 5.0 V ± 0.5 V

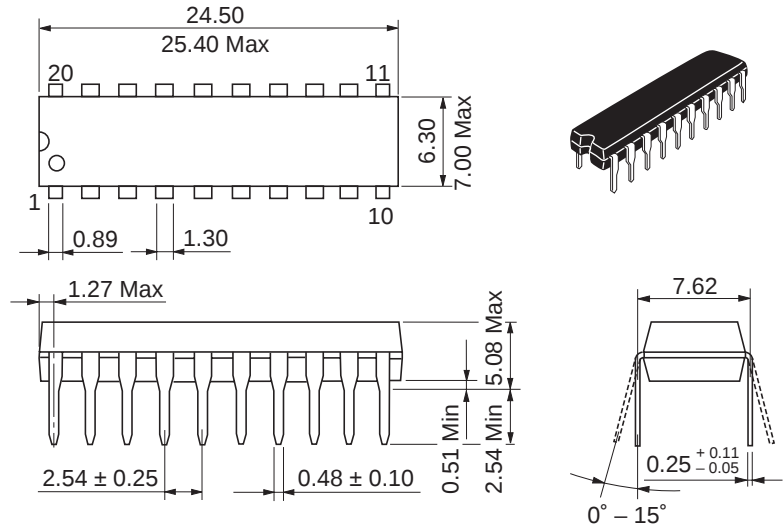
Capacitance

Item	Symbol	Typ	Unit	Condition
Input capacitance	C _{IN}	4.5	pF	V _{CC} = 5.5 V
Input/output capacitance	C _{I/O}	15.0	pF	V _{CC} = 5.5 V
Power dissipation capacitance	C _{PD}	45.0	pF	V _{CC} = 5.0 V

Package Dimensions

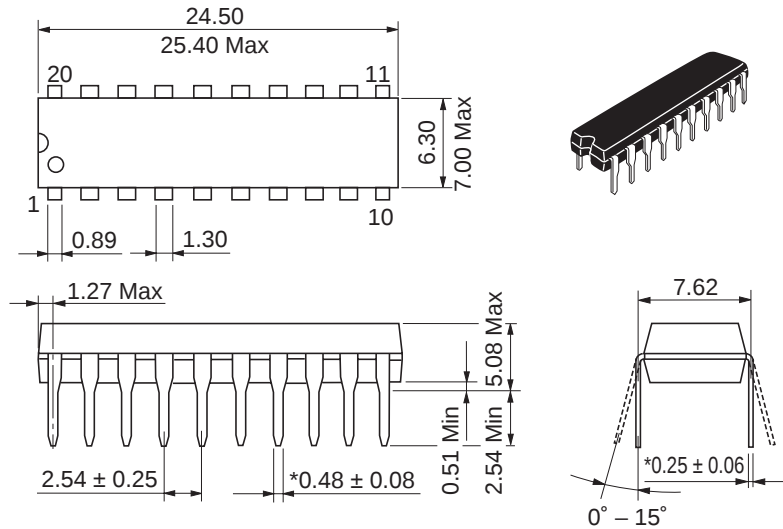
As of January, 2003

Unit: mm



Package Code	DP-20N
JEDEC	—
JEITA	Conforms
Mass (reference value)	1.26 g

Unit: mm

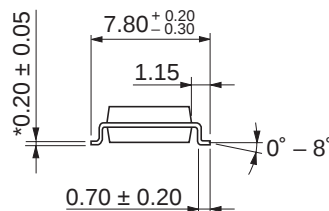
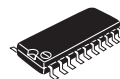
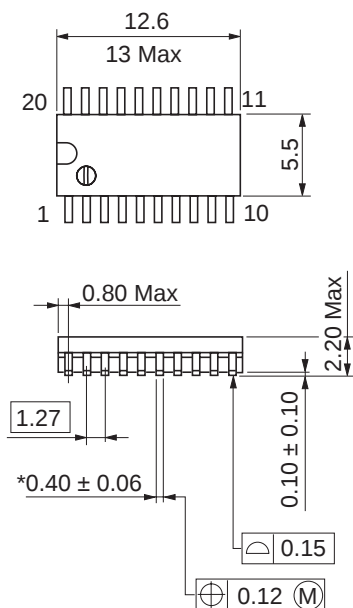


*Ni/Pd/AU Plating

Package Code	DP-20NEV
JEDEC	—
JEITA	Conforms
Mass (reference value)	1.26 g

As of January, 2003

Unit: mm

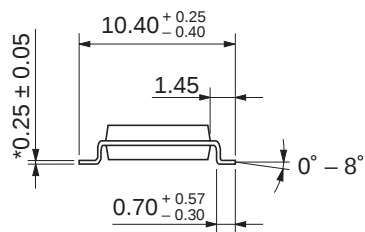
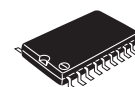
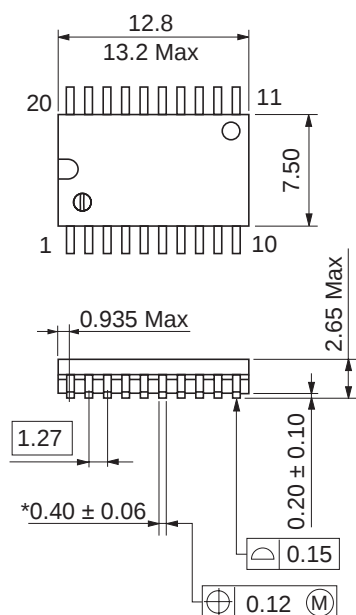


*Ni/Pd/Au plating

Package Code	FP-20DAV
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.31 g

As of January, 2003

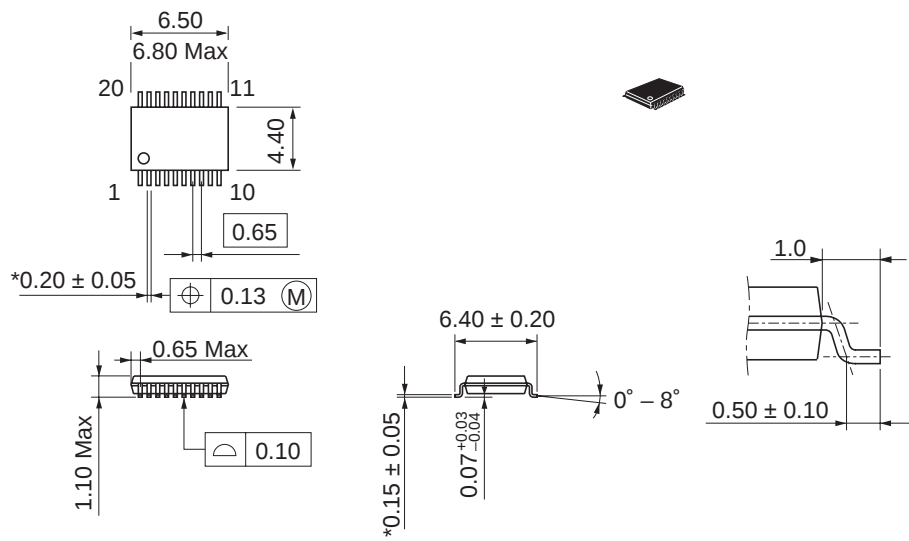
Unit: mm



*Ni/Pd/Au plating

Package Code	FP-20DBV
JEDEC	Conforms
JEITA	—
Mass (reference value)	0.52 g

As of January, 2003
Unit: mm



*Ni/Pd/Au plating

Package Code	TTP-20DAV
JEDEC	—
JEITA	—
Mass (reference value)	0.07 g

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